



# Device and Process Modeling in Microelectronics and Nanoelectronics

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## **Vision**

- To develop a highly integrated and intelligent simulation environment that facilitates the rapid development and validation of next-generation electronic devices as well as associated materials and fabrication processes through **virtual prototyping** at multiple levels of fidelity

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## Research Objectives

- Develop physical models to simulate new devices useful for NASA missions
- Develop computational framework based on advanced parallel algorithms and embed them into number of new emerging technologies
- Develop and deploy an intelligent simulation environment through the transparent and seamless integration of underlying Information Technology components

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## Devices and Applications

- **Devices**
  - Submicron and deep-submicron devices (ULSI)
  - Quantum devices
  - Optoelectronic devices
  - Micro-Electro-Mechanical (MEM) and ASIM devices ASIM
- **Applications**
  - Future high-performance computer systems
  - Smart spacecraft
  - Smart aircraft control systems
  - Air traffic management systems
  - High speed data communications
  - Optical storage
  - Optical sensors

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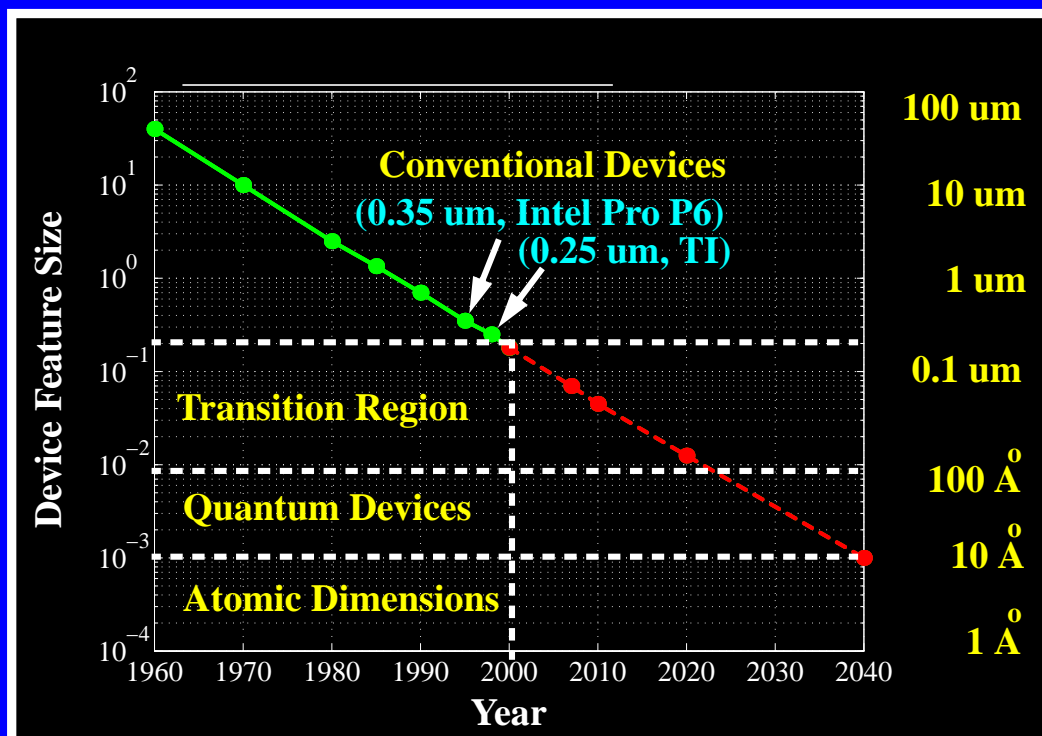
## Roadmap for Semiconductor Industry

1996 0.35 $\mu\text{m}$	1997 0.25 $\mu\text{m}$	1998 0.18 $\mu\text{m}$	2000 0.13 $\mu\text{m}$	2007 0.07 $\mu\text{m}$
Mercury 0.365 $\mu\text{m}$	Krypton-Fluoride UV laser 0.248 $\mu\text{m}$	Argon-Fluoride laser 0.193 $\mu\text{m}$	X-Ray Point Source	X-Ray Synchronized
		Phase Shift		
Production	Integration	Development	Research	Research
Current Generation	Next Generation	Third Generation	Fourth Generation	Fifth Generation

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## Quantum Devices



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## NASA HPC Requirements

- **High-Performance Computers**  
Ultrafast computers for critical missions
- **Low-powered**  
Higher Tflops/Pflops per watt
- **Ultra Compact**  
Higher Tflops/Pflops per square foot
- **Resistant to Radiation Damage**  
The NASA Remote Exploration and Experimentation Project: High Performance Computing in Space

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## Benefits of Technology Modeling

- Design times may be reduced in half
- Advanced technologies can be investigated “on-the-fly”
- Physical prototypes can be eliminated
- Initial design quality can be improved, resulting in significant life-cycle cost reductions
- Basic understanding of the device operation through 3-D visualization
- Vastly less expensive than experiment
- Modify device and test conditions at will

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# Higher-Level Technical Approach

- **Physical models framework**
  - Semiclassical methods
  - Quantum mechanical methods
- **Computational framework**
  - PDE/Integrals based methods
  - Particle based methods
- **Information Technology framework**
  - Hardware
  - Software

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# Physical Models Framework

## Microscopic Methods

**Stochastic Methods**  
Fullband Monte Carlo  
Reduced Band MC

**Deterministic Methods**  
Scattering matrix  
Cellular Automata

**Non-equilibrium Methods**  
Green's Functions

## Macroscopic Methods

**Series Expansion Methods**  
Spherical Harmonics  
Laugurre Polynomials

**Moment Methods**  
Classical HD  
Quantum HD

**Energy Transport Methods**  
Drift-diffusion  
Energy Balance

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## Computational Framework

- **PDE/Integral equations based methods**
  - Multilevel algorithms
  - Fully adaptive methods
  - Unstructured mesh methods
  - Level set methods
- **Particle methods**
  - Gridless methods
  - Gridded methods
- **Scalable Algorithms**
  - Latency tolerant algorithms
  - Data locality
  - Load balance methods

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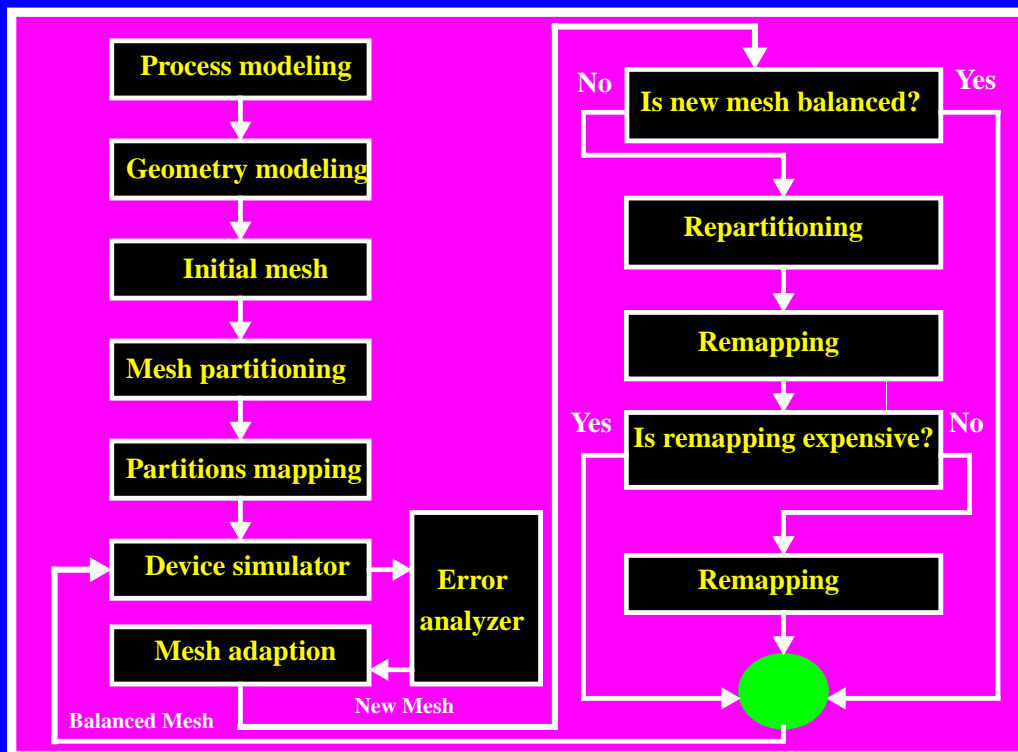
## Information Technology Framework

- **Hardware**
  - Parallel computers
  - Mass storage devices
  - Virtual reality systems
  - High speed networks
- **Software**
  - Computational steering capability
  - Databases/Data management systems
  - Distributed computing environments
  - Artificial intelligence/Expert systems
  - Visualization software
  - Graphical user interfaces

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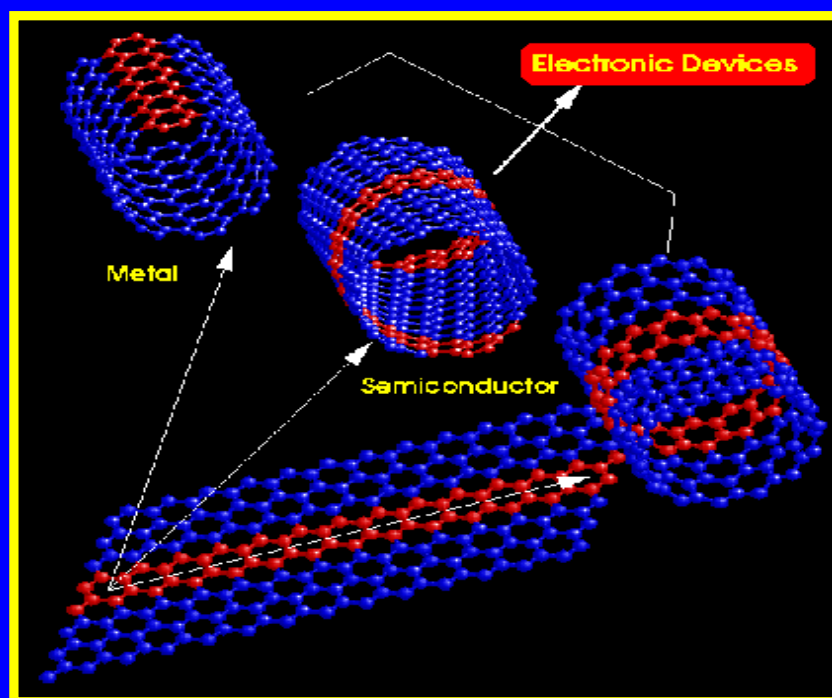
## Parallel Adaptive Device Simulator



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## Metallic and Semiconductor Single-Walled Carbon Nanotubes

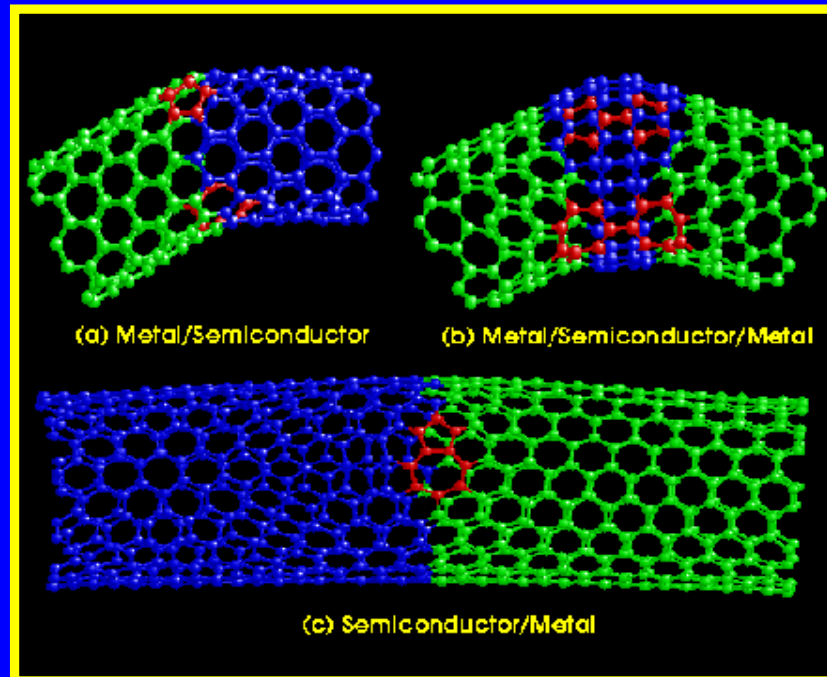


Jie Han, 1997

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## Fullerene-based Hetero-junctions



Jie Han, 1997

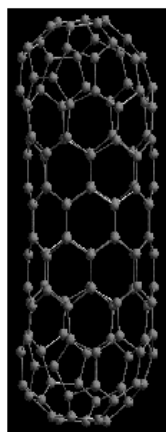
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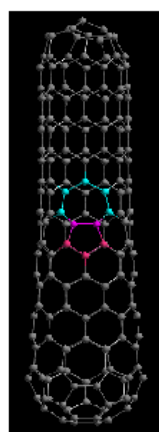
## Nanotube Hetero-junction

Example: Carbon Nanotube Switch

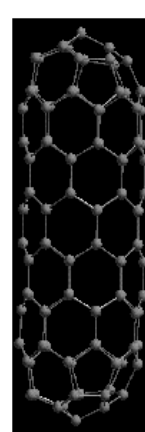
Tube (8,0)    Junction (8,0)-(7,1)    Tube (7,1)



Metallic



Metal/Semiconductor  
Junction



Semiconducting

Srivastava & Menon, 1997

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# Bandstructure of Nanotubes

